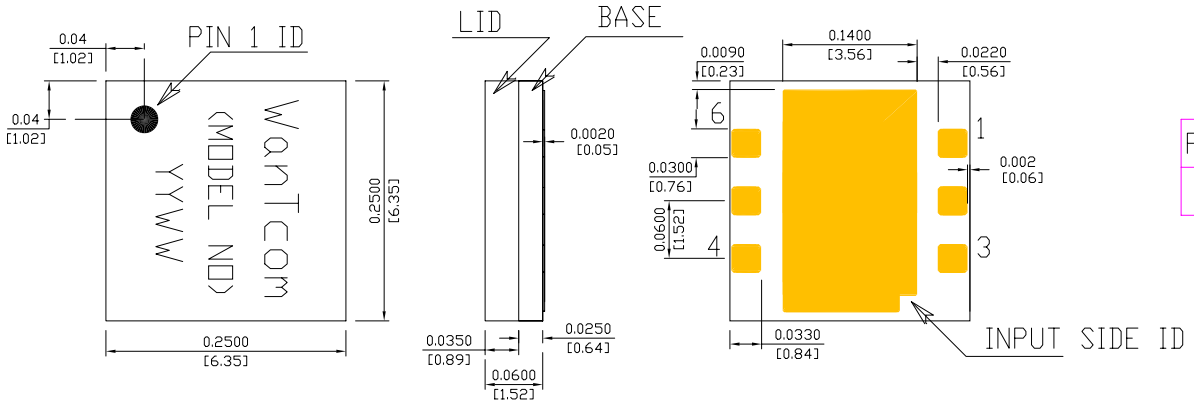
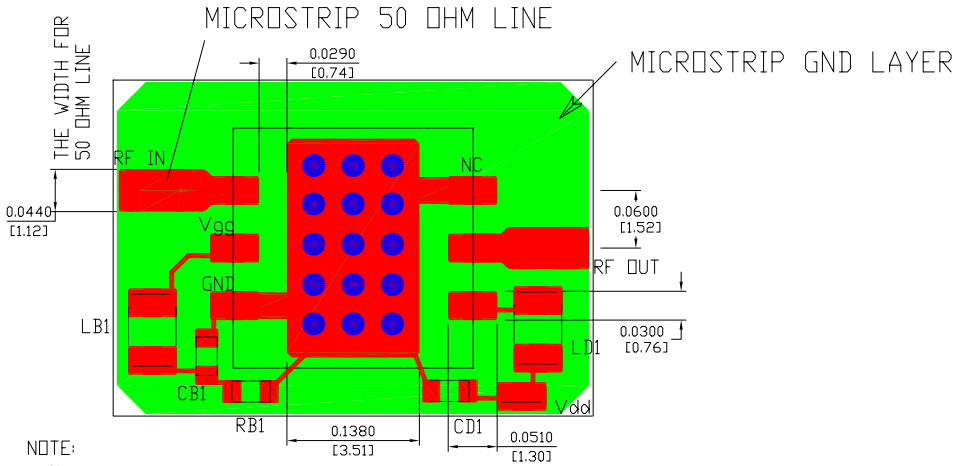
DISCRIPTIONS				
REV	DESCRIPTION	DATE	REV BY	RLSD BY
A	NEW RELEASE	3/11/04		GHu



PIN	1	2	3	4	5	6	CTR
ID	RF IN	Vgg	GND	Vdd	RF OUT	GND	GND



NOTE:

0) Vdd IN TO PIN 4
1) CB1 and CD1: 0.01UF,16V,X7R; LB1 and LD1: 6.8 uH Inductor.
2) PCB MATERIAL: RO4003, H=20 MILS, 1 OZ
3) ALL VIAS MUST BE PLATED
4) VIA DRILL DIAMETER: 0.024" OR EQUVALENT
5) WIDTH OF 50-OHM LINE MAY VARY WITH OTHER MATERIAL OR THICKNESS
6) SOLDER STENCIL THICKNESS: 0.004"
7) SOLDER MASK MATERIAL: LOW LOSS, EXAMPLE, PSR4000BN FROM TAIYO

THIRD ANGLE PROJECTION

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TOLERANCE UNLESS NOTED OTHERWISES

DIMENSIONS ARE IN INCHE/[MM]
X.XX +/- 0.05
X.XXX+/-0.010
X.XXXX+/-0.005

90° FORMED +/- 2°

MATERIAL: SEE THE NOTES

DONOT SCALE THE PRINT

DRAWN	GHu	9/1/03
DESIGN	GHu	9/1/03
INSPECT	YWa	9/5/03
QA		
MFG ENGR		
MFG ENGR MANAGER		
ENGR MANAGER		11/1/03

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PROD DESC	WHM-1M OUTLINE OUTLINES		
DOC DESC	1) PACKAGE 2)TEST BOARD		
DOC NO.	2000149		REV A
ELECTRONIC DRAWING: HW2	SCALE 1 X	PAGE 1/1	